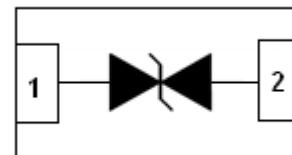


**FEATURES:**

- ✧ Small body outline dimensions :0.6mm×0.3mm
- ✧ Low clamping voltage
- ✧ Low operating voltage: 5.0V
- ✧ Low capacitance:0.15pF(typ.)
- ✧ Low leakage current:0.01μA(typ.)
- ✧ ROHS compliant



DFN0603-2L



PIN Configuration

**MAIN APPLICATIONS**

- ✧ Cell phone handsets and accessories
- ✧ Personal digital assistants (PDA's)
- ✧ Notebooks, desktops, and servers
- ✧ Portable instrumentation
- ✧ Communication systems
- ✧ Microprocessor based equipment

**PROTECTION SOLUTION TO MEET**

- ✧ IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- ✧ IEC61000-4-4 (EFT) 40A (5/50ns)
- ✧ IEC61000-4-5(Lightning) 4A (8/20μs)

**MECHANICAL CHARACTERISTICS**

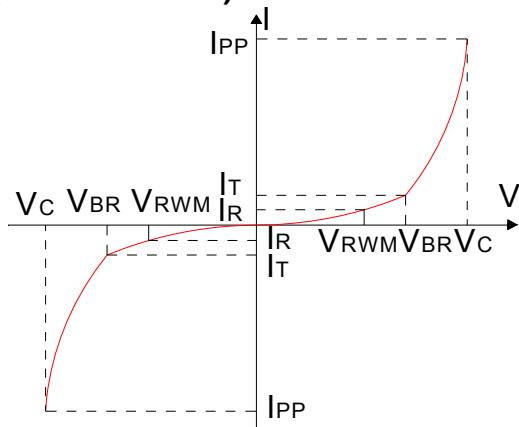
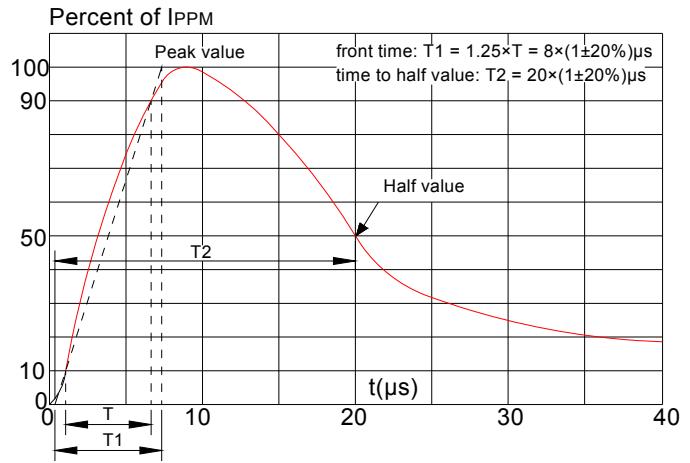
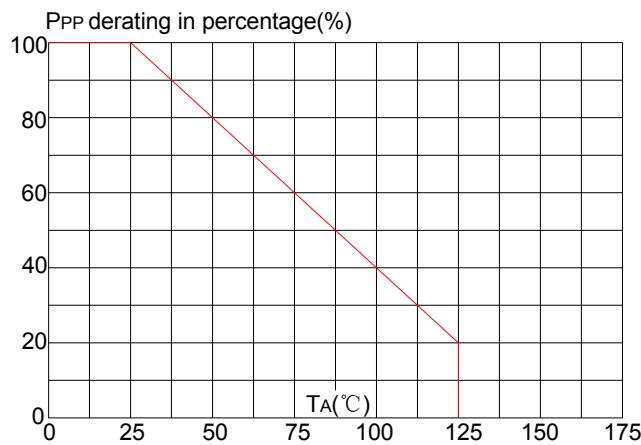
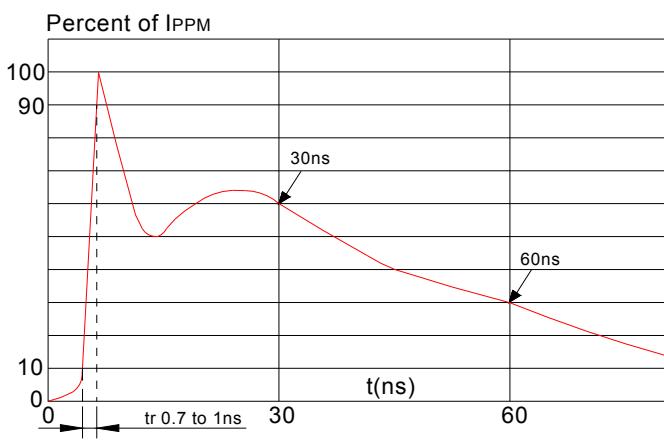
- ✧ DFN0603-2L package
- ✧ Molding compound flammability rating : UL 94V-0
- ✧ Quantity per reel : 15,000pcs
- ✧ Lead finish : lead free
- ✧ Marking code: C

**ABSOLUTE MAXIMUM RATINGS** ( $T_A=25^\circ\text{C}$ , RH=45%-75%, unless otherwise noted)

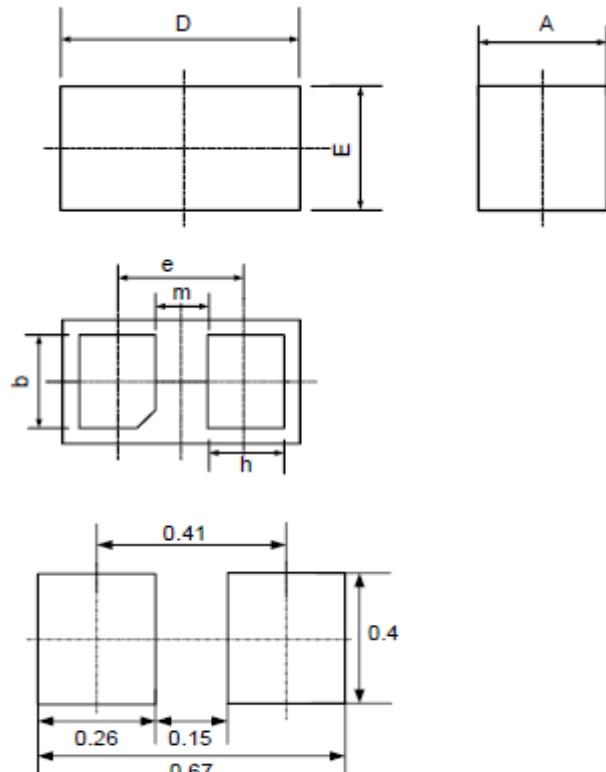
Parameter	Symbol	Value	Unit
Peak pulse power current on 8/20 μs waveform	$I_{PP}$	4	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	$V_{ESD}$	+/-15 +/-8	kV
Lead soldering temperature	$T_L$	260 (10 sec.)	°C
Operating junction temperature range	$T_J$	-40 to +125	°C
Storage temperature range	$T_{STG}$	-55 to +150	°C

ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse working voltage	$V_{RWM}$				5.0	V
Reverse breakdown voltage	$V_{BR}$	$I_T=5\text{mA}$	5.5			V
Reverse leakage current	$I_R$	$V_{RWM} = 5\text{V}$		0.01	1.0	$\mu\text{A}$
Peak pulse current	$I_{PP}$	$t_P = 8/20\mu\text{s}$			4	A
Clamping voltage	$V_C$	$I_{PP} = 4\text{A}$ , $t_P = 8/20\mu\text{s}$		14	17	V
Junction capacitance	$C_J$	$V_{RWM} = 0\text{V}$ , $f = 1\text{MHz}$		0.15	0.20	pF

RATINGS AND V-I CHARACTERISTICS CURVES ( $T_A=25^\circ\text{C}$ , unless otherwise noted)**FIG.1: V-I curve characteristics (Bi-directional)****FIG.2: Pulse waveform (8/20μs)****FIG.3: Pulse derating curve****FIG.4: ESD clamping (8KV contact)**

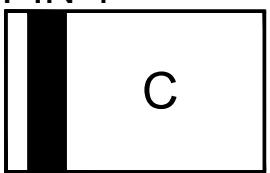
## PACKAGE MECHANICAL DATA



Land Pattern

Symbol	Millimeter	
	Min.	Max.
A	0.28	0.32
D	0.55	0.65
E	0.25	0.35
b	0.20	0.30
e	0.350	
m	0.165	
h	0.14	0.24

## MARKING CODE

Part Number	Marking Code
JEB05ULCDS-A	PIN 1 

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